



Parameter	Rating	Units
Blocking Voltage	600	$V_P$
Load Current	1	$A_{rms} / A_{DC}$
On-Resistance (max)	0.66	$\Omega$
Input / Output Isolation	4000	$V_{rms}$

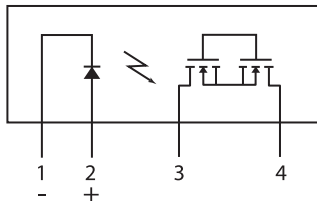
### Features

- 4000 $V_{rms}$  Input/Output Isolation
- Handle Load Currents Up to 1A
- 600 $V_P$  Blocking Voltage
- Power SIP Package
- High Reliability
- Low Drive Power Requirements
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Flammability Rating UL 94 V-0

### Applications

- Industrial Controls
- Motor Control
- Robotics
- Medical Equipment—Patient/Equipment Isolation
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- IC Equipment
- Home Appliances

### Pin Configuration



### Description

The CPC1984Y single-pole normally open (1-Form-A) 600V Solid State Power Relay has a  $1A_{DC} / 1A_{rms}$  continuous load current rating.

Patented OptoMOS® optically coupled MOSFET technology, controlled by a highly efficient infrared LED, provides the CPC1984Y with 4000 $V_{rms}$  of input to output isolation.

The combination of low on-resistance and high load current handling capability makes this relay ideal for a variety of high performance switching applications.

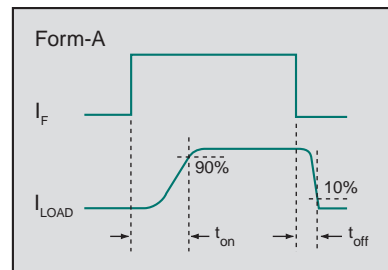
### Approvals

- UL 508 Recognized Component: File E69938

### Ordering Information

Part #	Description
CPC1984Y	4-Pin (8-Pin Body) Power SIP Package (25 per tube)

### Switching Characteristics of Normally Open Devices



### Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	600	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation <sup>1</sup>	150	mW
Total Power Dissipation <sup>2</sup>	1600	mW
Isolation Voltage, Input to Output (60 Seconds Maximum) <sup>3</sup>	4000	V <sub>rms</sub>
ESD Rating, Human Body Model	4	kV
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

<sup>1</sup> Derate linearly 1.33mW/°C

<sup>2</sup> Derate linearly 16mW/°C

<sup>3</sup> UL File 69938 is rated to 2500V<sub>rms</sub> by UL.

### Electrical Characteristics @ 25°C (Unless Otherwise Noted)

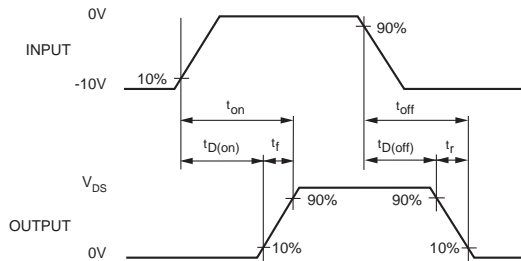
Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Load Current, Continuous <sup>1</sup>	I <sub>F</sub> =5mA, Free air	I <sub>L</sub>	-	-	1	A
Load Current, Peak	I <sub>F</sub> =5mA, t=10ms	I <sub>LPK</sub>	-	-	5	A <sub>p</sub>
On-Resistance <sup>2</sup>	I <sub>F</sub> =5mA, I <sub>L</sub> =1A	R <sub>ON</sub>	-	0.51	0.66	Ω
Off-State Leakage Current	I <sub>F</sub> =0mA, V <sub>L</sub> =600V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μA
<b>Switching Speeds</b>						
Turn-On	I <sub>F</sub> =5mA, I <sub>L</sub> =1A	t <sub>on</sub>	-	2.26	10	ms
Turn-Off		t <sub>off</sub>	-	0.35	2	
Output Capacitance	I <sub>F</sub> =0mA, V=20V <sub>DC</sub> , f=1MHz	C <sub>OUT</sub>	-	1.18	-	nF
<b>Input Characteristics</b>						
Input Control Current to Activate <sup>3</sup>	I <sub>L</sub> =1A	I <sub>F</sub>	-	0.47	5	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	-	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.36	1.5	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
<b>Input/Output Characteristics</b>						
Capacitance, Input-to-Output	V <sub>IO</sub> =0V <sub>DC</sub> , f=1MHz	C <sub>IO</sub>	-	2	-	pF

<sup>1</sup> Load derates linearly from 1000mA @ 25°C to 650mA @ 85°C (5.83mA/°C).

<sup>2</sup> Measurement taken within 1 second of on-time.

<sup>3</sup> For applications requiring high temperature operation (>60°C) a minimum LED drive current of 10mA is recommended.

### Switching Waveforms

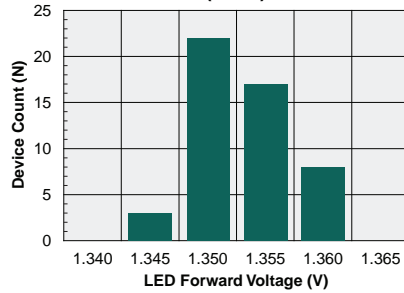


### Thermal Characteristics

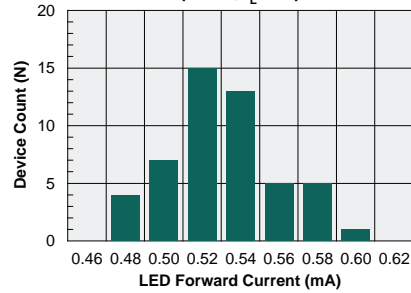
Parameter	Symbol	Rating
Thermal Impedance (Junction to Ambient)	θ <sub>JA</sub>	62.5°C/W

**PERFORMANCE DATA\***

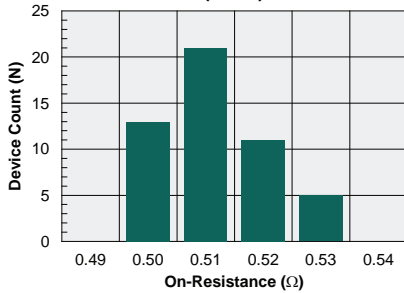
**Typical LED Forward Voltage Drop (N=50)**



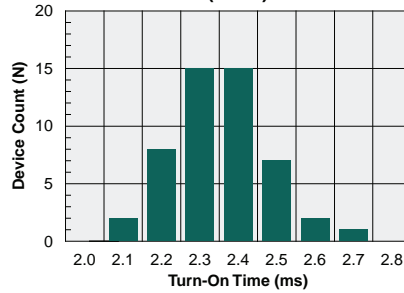
**Typical  $I_F$  for Switch Operation (N=50,  $I_L=1A$ )**



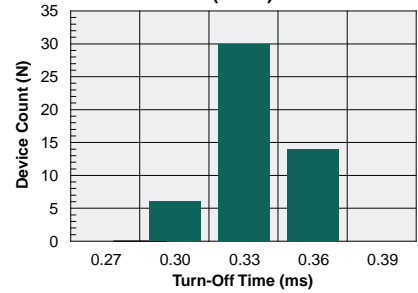
**Typical On-Resistance Distribution (N=50)**



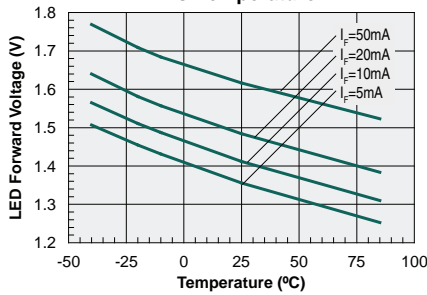
**Typical Turn-On Time Distribution (N=50)**



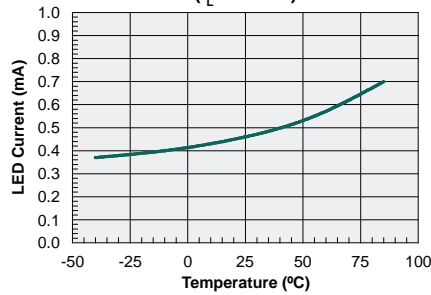
**Typical Turn-Off Time Distribution (N=50)**



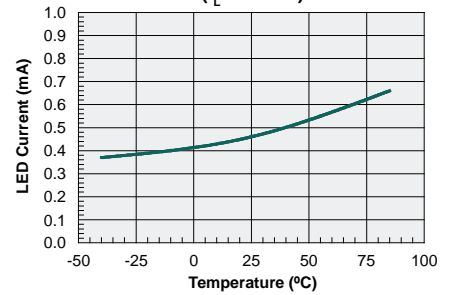
**LED Forward Voltage Drop vs. Temperature**



**Typical  $I_F$  for Switch Operation vs. Temperature ( $I_L=100mA$ )**



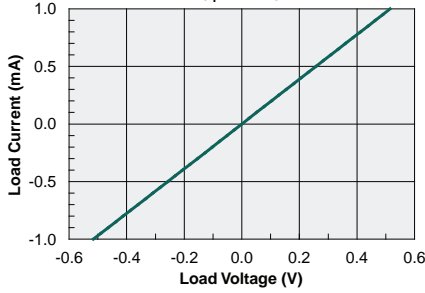
**Typical  $I_F$  for Switch Dropout vs. Temperature ( $I_L=100mA$ )**



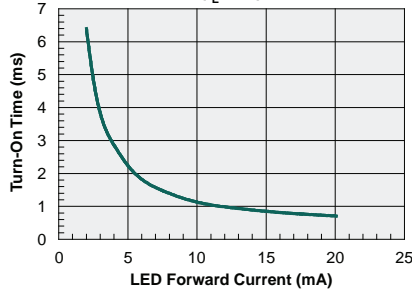
\*The Performance data shown in the graphs above is typical of device operation. Unless otherwise noted, data is presented at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**PERFORMANCE DATA\***

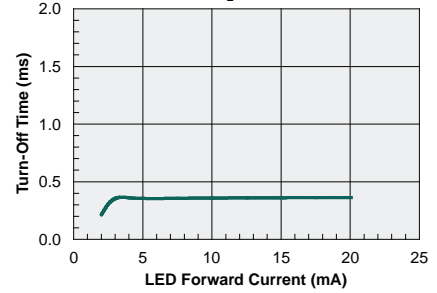
**Typical Load Current vs. Load Voltage**  
( $I_F=5mA$ )



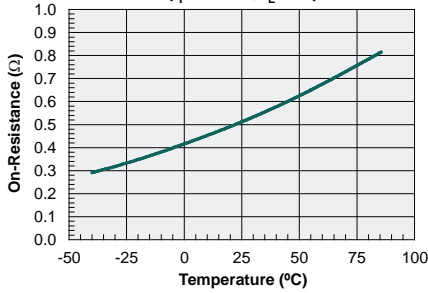
**Typical Turn-On Time vs. LED Forward Current**  
( $I_L=1A$ )



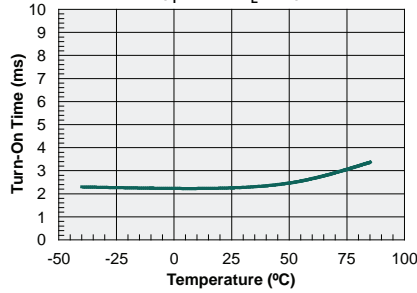
**Typical Turn-Off Time vs. LED Forward Current**  
( $I_L=1A$ )



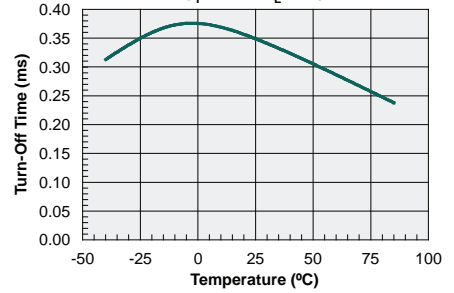
**Typical On-Resistance vs. Temperature**  
( $I_F=10mA, I_L=1A$ )



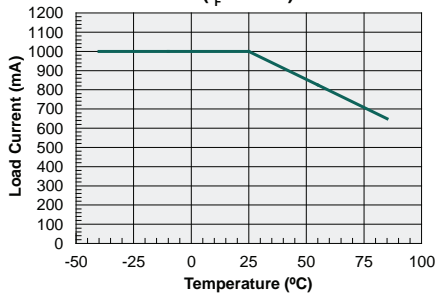
**Typical Turn-On Time vs. Temperature**  
( $I_F=5mA, I_L=1A$ )



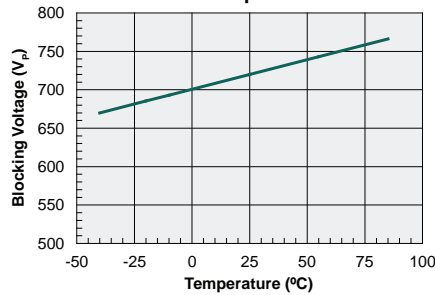
**Typical Turn-Off Time vs. Temperature**  
( $I_F=5mA, I_L=1A$ )



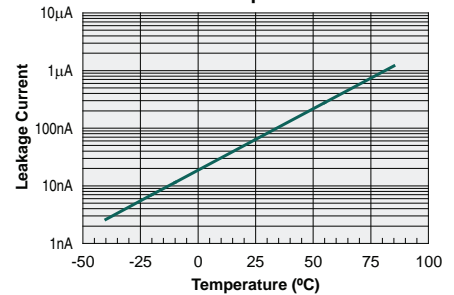
**Maximum Load Current vs. Temperature**  
( $I_F=10mA$ )



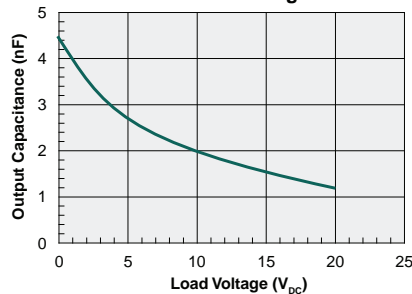
**Typical Blocking Voltage vs. Temperature**



**Typical Leakage Current vs. Temperature**



**Typical Output Capacitance vs. Load Voltage**



\*The Performance data shown in the graphs above is typical of device operation. Unless otherwise noted, data is presented at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1984Y	MSL 1

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Soldering Profile

Provided in the table below is the Classification Temperature ( $T_C$ ) of this product and the maximum dwell time the body temperature of this device may be ( $T_C - 5$ )°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature ( $T_C$ )	Dwell Time ( $t_p$ )	Maximum Cycles
CPC1984Y	245°C	30 seconds	1

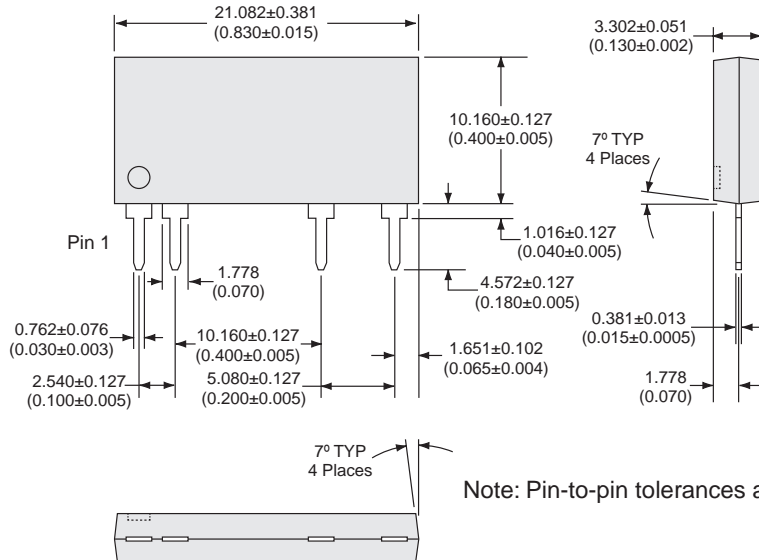
### Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.

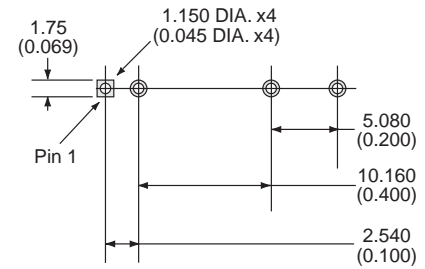


### MECHANICAL DIMENSIONS

#### CPC1984Y Power SIP Package



#### PCB Hole Pattern



Note: Pin-to-pin tolerances are non-cumulative.

Dimensions  
mm  
(inches)

For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.

Specification: DS-CPC1984Y-R01  
 ©Copyright 2018, IXYS Integrated Circuits Division  
 OptoMOS® is a registered trademark of IXYS Integrated Circuits Division  
 All rights reserved. Printed in USA.  
 7/26/2018